

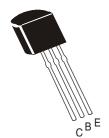
Continental Device India Limited

An ISO/TS 16949, ISO 9001 and ISO 14001 Certified Company





NPN SILICON PLANAR EPITAXIAL TRANSISTORS



BC549,A.B,C BC550,A,B,C

TO-92
Plastic Package
For Lead Free Parts, Device
Part # will be Prefixed with
"T"

Low Noise Transistors

ABSOLUTE MAXIMUM RATINGS (T_a=25°C)

DESCRIPTION	SYMBOL	BC549	BC550	UNITS	
Collector Emitter Voltage	V _{CEO}	30	45	V	
Collector Base Voltage	V _{CBO}	30	50	V	
Emitter Base Voltage	V _{EBO}	5.0			
Collector Current Continuous	I _C	100			
Power Dissipation at T _a =25°C	P _D	625			
Derate Above 25ºC		5.0			
Power Dissipation at T _c =25°C	P _D	1.5			
Derate Above 25ºC		12			
Operating And Storage Junction	T_{j},T_{stg}	- 55 to +150			
Temperature Range	'j, 'stg	- 55 to +150			

THERMAL RESISTANCE

Junction to Case	R _{th (j-c)}	83.3	ºC/W
Junction to Ambient in free air	R _{th (i-a)}	200	ºC/W

ELECTRICAL CHARACTERISTICS (T_a=25°C unless specified otherwise)

DESCRIPTION	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS
Collector Emitter Voltage	V _{CEO}	$I_C=1$ mA, $I_B=0$				
		BC549	30			V
		BC550	45			V
Collector Base Voltage	V _{CBO}	$I_{C}=100\mu A,\ I_{E}=0$				
		BC549	30			V
		BC550	50			V
Emitter Base Voltage	V_{EBO}	$I_{E}=10\mu A,\ I_{C}=0$	5.0			V
Collector Cut Off Current	I _{CBO}	$V_{CB}=30V$, $I_{E}=0$			15	nA
		$V_{CB}=30V$, $I_{E}=0$, $T_{a}=+125$ $^{\circ}C$			5.0	μΑ
Emitter Cut Off Current	I _{EBO}	$V_{EB}=4V$, $I_{C}=0$			15	nA

NPN SILICON PLANAR EPITAXIAL TRANSISTORS

C_BE

BC549,A.B,C BC550,A,B,C

TO-92
Plastic Package
For Lead Free Parts, Device
Part # will be Prefixed with
"""

ELECTRICAL CHARACTERISTICS (T_a=25°C unless specified otherwise)

DESCRIPTION	SYMBOL	TEST CONDITION	ON	MIN	TYP	MAX	UNITS
DC Current Gain	h _{FE}	$I_C=10\mu A, V_{CE}=5V$	B/C	100			
		$I_C=2mA$, $V_{CE}=5$	V				
		BC549A/BC550	Α	110		220	
		BC549B/550B	}	200		450	
		BC549C/550C	;	420		800	
		BC549/550		110		800	
Collector Emitter Saturation Voltage	V _{CE (sat)}	$I_C=10$ mA, $I_B=0.5$ mA				0.25	V
		I _C =10mA, I _B =See Note (1)				0.60	V
		$^*I_C=100$ mA, $I_B=5$ r	mA			0.60	V
Base Emitter Saturation Voltage	*V _{BE (sat)}	$I_C=100$ mA, $I_B=5$	mA		1.1		V
Base Emitter On Voltage	V _{BE (on)}	$I_C=10\mu A, V_{CE}=5$	V		0.52		V
		$I_{C}=100\mu A, V_{CE}=5$	5V		0.55		V
		$I_C=2mA$, $V_{CE}=5$	V	0.55		0.70	V

SMALL SIGNAL CHARACTERISTICS

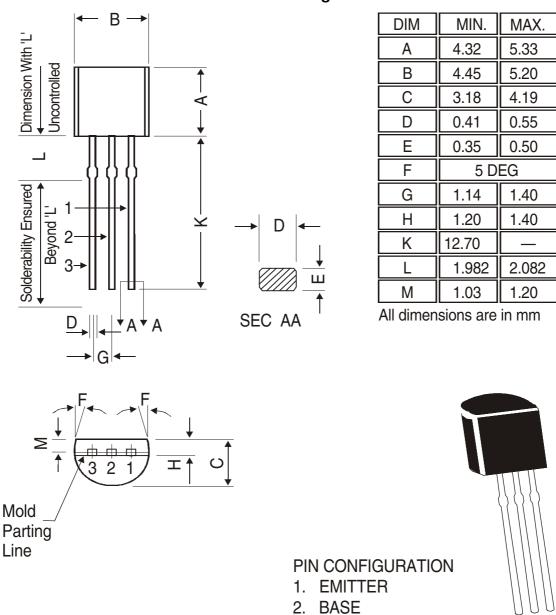
DESCRIPTION	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS
Transistors Frequency	f_T	$I_C=10$ mA, $V_{CE}=5$ V, $f=100$ MHz		250		MHz
Collector Base Capacitance	C_{cbo}	$V_{CE}=10V$, $I_{E}=0$, $f=1MHz$		2.5		pF
Small Signal Current	h _{fe}	$I_C=2mA$, $V_{CE}=5V$, $f=1KHz$				
		BC549/550	125		900	
		BC549B/550B	240		500	
		BC549C/550C	450		900	
Noise Figure	NF	I_C =200μA, V_{CE} =5V, R_S =2 kΩ, f=30 Hz - 15KHz			2.5	dB
		I_C =200μA, V_{CE} =5V, R_S =100 $k\Omega$, f =1KHz			10	dB

Note 1- I_B is value for which I_C = 11mA at V_{CE} =1V *Pulse Test = 300 μ s - Duty Cycle = 2%

2 1

TO-92
Plastic Package
For Lead Free Parts, Device
Part # will be Prefixed with

TO-92 Plastic Package



The TO-92 Package, Tape and Ammo Pack drawings are correct as on the date of issue/revision of this Data Sheet.

The currently valid dimensions and information, may please be confirmed from the TO-92 Drawing in the Packages and Packing Section of the Product Catalogue.

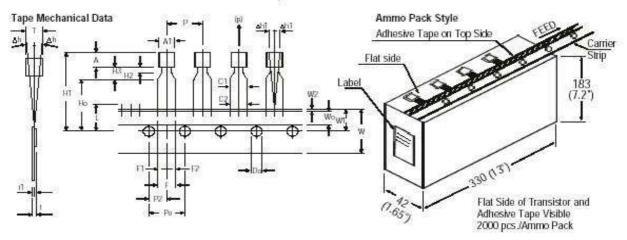
Packing Details

PACKAGE	STANDARD PACK		INNER CARTON BOX		OUTER CARTON BOX		
	Details	Net Weight/Qty	Size Qty S		Size Qty		Gr Wt
TO-92 Bulk	1K/polybag	200 gm/1K pcs	3" x 7.5" x 7.5"	5K	17" x 15" x 13.5"	80K	23 kgs
TO-92 T&A	2K/ammo box	645 gm/2K pcs	12.5" x 8" x 1.8"	2K	17" x 15" x 13.5"	32K	12.5 kgs

3. COLLECTOR

TO-92 Plastic Package For Lead Free Parts, Device Part # will be Prefixed with

TO-92 Tape and Ammo Pack



All dimensions are in mm

		SPECIFICATION			ON	
ITEM	SYMBOL	MIN.	NOM.	MAX.	TOL.	
BODY WIDTH	A1	4.45		5.20		NOTES
BODY HEIGHT	A	4.32		5.33		Maximum alignment deviation between
BODY THICKNESS	T	3.18		4.19		leads will not to be greater than 0.2mm.
PITCH OF COMPONENT	P		12.7		± 1.0	Maximum non-cumulative variation
*1FEED HOLE PITCH	Po		12.7		± 0.3	between tape feed holes shall not
*2 FEED HOLE CENTRE TO	00000		ACCIONAL			exceed 1 mm in 20 pitches.
COMPONENT CENTRE	P2		6.35		± 0.4	3. Holddown tape will not exceed beyond
DISTANCE BETWEEN OUTER LEADS	E		5.08		+ 0.6	the edge(s) of carrier tape and there shall be no exposure of adhesive.
*3 COMPONENT ALIGNMENT SIDE VIEW	Δh		0	1.0		4. There will be no more than three (3)
*4 COMPONENT ALIGNMENT FRONT VIEW	∆h1		0	1.3		consecutive missing components in a
TAPE WIDTH	W		18	30.57%	± 0.5	tape.
HOLD-DOWN TAPE WIDTH	Wo		6		± 0.2	A tape trailer, having at least three feed
HOLE POSITION	W1		9		+ 0.7	holes are provided after the last component in a tape.
HOLD-DOWN TAPE POSITION	W2	0.0		0.7		Splices should not interfere with the
LEAD WIRE CLINCH HEIGHT	Ho	340200000	16	W-06856010	± 0.5	sprocket feed holes.
COMPONENT HEIGHT	H1		985	24.0		
LENGTH OF SNIPPED LEADS	Ě			11.0		
FEED HOLE DIAMETER	Do		4		± 0.2	REMARKS
*5 TOTAL TAPE THICKNESS	t			1.2		
LEAD - TO - LEAD DISTANCE	F1, F2	2.40		2.70	8727	*1 Cumulative pitch error 1.0 mm/20 pitch
STAND OFF	H2	0.45		1.45	- 0.1	*2 To be measured at bottom of clinch
CLINCH HEIGHT	Н3			3.0		*3 At top of body
LEAD PARALLELISM	[C1 - C2]			0.22		*4 At top of body
PULL - OUT FORCE	(p)	6N				*5 t1 0.3 - 0.6 mm

Component Disposal Instructions

- 1. CDIL Semiconductor Devices are RoHS compliant, customers are requested to please dispose as per prevailing Environmental Legislation of their Country.
- 2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).

Customer Notes

BC549,A.B,C BC550.A.B.C

TO-92
Plastic Package
For Lead Free Parts, Device
Part # will be Prefixed with
"T"

Disclaimer

The product information and the selection guides facilitate selection of the CDIL's Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished in the Data Sheet and on the CDIL Web Site/CD are believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information. Furthermore, CDIL does not assume liability whatsoever, arising out of the application or use of any CDIL product; neither does it convey any license under its patent rights nor rights of others. These products are not designed for use in life saving/support appliances or systems. CDIL customers selling these products (either as individual Semiconductor Devices or incorporated in their end products), in any life saving/support appliances or systems or applications do so at their own risk and CDIL will not be responsible for any damages resulting from such sale(s).

CDIL strives for continuous improvement and reserves the right to change the specifications of its products without prior notice.

